MARKING OF ENVELOPES

FIRST ENVELOPE

Original - Legal and Technical Component

BIDDER'S NAME & ADDRESS

ORIGINAL – LEGAL & TECHNICAL COMPONENT

USTP – CDO CAMPUS BIDS AND AWARDS COMMITTEE
UNIVERSITY OF SCIENCE AND TECHNOLOGY OF SOUTHERN PHILIPPINES
C.M. RECTO AVE., LAPASAN, CAGAYAN DE ORO CITY

PROPOSED PROCUREMENT OF THE SUPPLY AND DELIVERY OF ICT EQUIPMENT FOR USTP-OROQUIETA CAMPUS CY 2023

ABC: P2,499,999.60

DO NOT OPEN BEFORE NOVEMBER 06, 2023, 09:30 A.M.

Copy No. 1 - Legal and Technical Component

BIDDER'S NAME & ADDRESS

COPY NO. 1 – LEGAL & TECHNICAL COMPONENT

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SECOND ENVELOPE

Original - Financial Component

BIDDER'S NAME & ADDRESS

ORIGINAL – FINANCIAL COMPONENT

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Copy No. 1 - Financial Component

BIDDER'S NAME & ADDRESS

COPY NO. 1- FINANCIAL COMPONENT

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Note:

- 1. Each Bidder shall submit One (1) original and One (1) Additional hard copy of the first and second components of its bid:
- 2. One (1) electronic copy through Flash Drive of the first component of its bid;
- 3. NOTE: Each Legal & Technical Component shall be sealed in an envelope and enclose them all in an outer envelope;
- 4. NOTE: Each Financial Component shall be sealed in an envelope and enclose them all in an outer envelope;
- Each Legal & Technical Component and Financial Component shall be enclosed in ONE SINGLE ENVELOPE; and
- 6. Each envelope should be properly labeled, sealed, and signed.

